1. MATERIAL HOUSING = HTN NYLON, BLACK, IN REFLOW PROCESSING COMPATIBLE, UL 94V-0.
   TERMINALS = .013[0.33] THICK PHOS BRONZE PLATED WITH .000050[1.27μm] THICK HARD GOLD IN LOCALIZED AREA AND .000150[3.81μm] THICK MATTE TIN IN SOLDER AREA OVER .000050[1.27μm] THICK NICKEL UNDERPLATE.

2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART E.

3. ALL DIMENSIONS SHOWN ARE NOMINAL UNLESS OTHERWISE SPECIFIED.

4. ALL DIMENSIONS SHOWN IN BRACKETS [ ] ARE IN MILLIMETERS.

SUGGESTED PANEL CUTOUT

SUGGESTED PCB BOARD LAYOUT

COMPONENT SIDE

SEE APPLICATION SPECIFICATION